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From: **W. Daniel Swayze, Jr.**
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5633

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Ashdown

Docket Number: TI-30240

Serial No.: 09/747,599

Filed: 12/22/00

Art Unit: 2814

Examiner: D. Nguyen

For: **METHOD AND APPARATUS FOR SURFACE MOUNTED POWER
TRANSISTOR WITH HEAT SINK**

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NAME OF INVENTOR(S): Ashdown	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/747,599 Filing Date: 12/22/00	
TITLE OF INVENTION: METHOD AND APPARATUS FOR SURFACE MOUNTED POWER TRANSISTOR WITH HEAT SINK	
TI FILE NO.: TI-30240	DEPOSIT ACCT. NO.: 20-0668
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265